

PolyOn Corporation
PolyOne Center
33587 Walker Road
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PATENT

Docket No.

1200302R

22264 U.S.PTO
10/77213

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Application Transmittal Letter

Mail Stop: Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Inventor(s): **Sang H. LEE and Robert B. HOOKS**
Title: **PROFILE-EXTRUDED POLY(VINYL CHLORIDE)
ARTICLES AND METHOD OF MAKING SAME**

Enclosed is the above-mentioned new patent application. It includes 14 pages of text and 2 sheet(s) of drawings.

Enclosed are an application assignment to **PolyOne Corporation** and a completed Assignment Recordation Cover Sheet.

Enclosed is a Declaration and Power of Attorney from the Inventor(s).

Enclosed is

The fee for filing the application is computed as follows:

Claims As Filed				
(1) For	(2) Number Filed	(3) Number Extra	(4) Rate	(5) Basic Fee
Total Claims	20 -20 =	0	x \$18.	\$0
Independent Claims	2 -3 =	0	x \$86.	\$0
Additional fee for filing one or more multiple dependent claims			\$290.	\$0
			Total amount due →	\$770

Please charge to **Deposit Account 07-1077** any fees under 37 CFR 1.16 and 1.17 which may be required to file and during the entire pendency of this application. This authorization includes the fee for any extension of time under 37 CFR 1.136(a) that may be necessary. To the extent any such extension should become necessary it is hereby requested.

Registration Number 29,393	Telephone Number 440-930-3317
Date February 4, 2004	

Signature <i>John H. Hornickel</i>
Print Name John H. Hornickel

Certificate of Express Mailing

Pursuant to 37 CFR 1.10 I certify that this application is being deposited on the date indicated below with the United States Postal Service "Express Mail Post Office to Addressee" service addressed to: **Mail Stop: Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450**

Express Mail Mailing Label No. EV 409556940 US
Date of Deposit February 4, 2004

Signature of Person Mailing Application <i>John H. Hornickel</i>
Printed Name of Person Mailing Application John H. Hornickel